FORM 100 VERSION 1.0 (October 27, 1990)

DECLARATION

SOLE INVENTOR/JOINT INVENTOR
ORIGINAL/CIP/DIVISIONAL

As a below named inventor, I hereby declare that: my residence, post office address, and citizenship are as stated below next to my name. I believe I am the original, first, and sole inventor (if only one name is listed below) or a joint inventor (if plural inventors are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

"Lo	w Capa	CITANCE ESD-PRO	rec1	TION STRUCTURE UND	er A Bond	PAD"	•	
as described in the specification \underline{X}	attached	or of Patent Applic	ation	s Serial No, f	iled	, and ame	nded on	·
(2) it refutes, or is inco	do not keep to describe the Unition; and accordance record of the Unition; and accordance record of the Unition; and the Unition; and the Unition of the Unition of the Unition of the United States o	now and do not believe ed in any printed publi has not been patented ited States of America that I acknowledge to be with Title 37, Code r being made of record combination with other	catio or n on a he di of I in th	same was ever known or in any country before in ande the subject of an in application filed by musty to disclose informational Regulations § 1.5 application, and immation, a prima facie can thas taken or may take in	used in the Uny or our involventor's certice or my legalon of which 56(a). Such it	Jnited States of a vention thereof of tificate issued be all representative I am aware when formation is m	America bor more the efore the or assigns ich is mal aterial wh	efore my or an one year date of this s more than terial to the
		nt of patentability.		in by the Office, or			·	•
I hereby claim foreign priority ben inventor's certificate, or 365(a) of a listed below and have also identifie having a filing date before that of the	ny PCT in d below,	nternational application any foreign application	ı whi n(s)	ch designated at least on for patent or inventor's o	e country oth	er than the Unit	ed States	of America,
COUNTRY	APPLIC	CATION NUMBER		DATE OF FILING		PRIORITY CL UNDER 35 US		
						□YES	■NO	
☐ Additional foreign application nu	mbers are	: listed on a supplemen	tal pr	iority data sheet PTO/SB	/02b attached	l hereto:		
I hereby claim the benefit under 35 t	JSC 119((e) of any United States	prov	visional application(s) list	ed below.			
APPLICATION NUMBER			DA	TE OF FILING				
☐ Additional provisional application	numbers	s are listed on a supple	ment	al priority data sheet PTO	/SB/02B atta	ched hereto:		
I hereby claim the benefit under 35 designating the United States of Arr United States or PCT International material information as defined in T the national or PCT international fili	erica, list application itle 37, Co	ted below and, insofar a on, in the manner prov ode of Federal Regulat	as an rided	y subject matter of any c by the first paragraph of	laim of this a	pplication is not 2, I acknowledge	disclosed e the duty	in the prior to disclose
U.S. Parent Application or PCT Parent Number		Parent Filing Date			Parent Pate	nt Number		: .
							٠	

HOU02:968766 Page 1 of 2

☐ Additional provisional application numbers are listed on a supplemental priority data sheet PTO/SB/02B attached hereto:

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

FULL NAME OF SOLE OR FIRST INVENTOR RANDY L. YACH	INVENTOR'S SIGNATURE	DATE 2-19-04
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MTI-2092.US.0

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant/Patentee:
Yach, Randy L.

Serial No.: To be Assigned

Serial No.: To be Assigned

Filed:

To be Assigned

Examiner:

To be Assigned

Title: "Low Capacitance ESD-Protection Structure Under a Bond Pad S

POWER OF ATTORNEY BY ASSIGNEE

Under the provisions of 37 C.F.R. § 3.71, the undersigned assignee of record of the entire interest in the above-identified patent/patent application by virtue of an assignment recorded (check as applicable):

X Concurrently Herewith
Date Recorded:
Reel/Frame:

elects to conduct the prosecution of the application/maintenance of the patent to the exclusion of the inventor(s). The undersigned hereby declares that he has reviewed the above-referenced assignment and hereby declares that, to the best of his knowledge, title is in the Assignee, and further declares that all statements made herein of his own knowledge are true and that all statements made on information and belief are believed to be true. The assignee hereby revokes any previous powers of attorney and appoints the following to prosecute this application/maintain this patent and transact all business in the Patent and Trademark Office connected therewith:

Please direct all communications to: Baker Botts L.L.P., One Shell Plaza, 910 Louisiana Street, Houston, Texas 77002-4995, 713.229.1343, Fax: 713.229.7743, attention of: Paul N. Katz.

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ASSIGNEE MICROCHIP TECHNOLOGY INC.

DATE: Feb 23, 2004

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